



Specification of Automotive MLCC

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10C820JC81PNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 82pF, 100V, ±5%, C0G, 0603

• AEC-Q 200 Specified

A. Samsung Part Number

<u>CL</u> <u>10</u> <u>C</u> <u>820</u> <u>J</u> <u>C</u> <u>8</u> <u>1</u> <u>P</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ® ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0603 (inch code)	L: 1.6	6 ± 0.1 mm	W:	0.8 ± 0.1	mm
3	Dielectric	COG	8	Inner electrode	Ni		
4	Capacitance	82 pF		Termination	Cu		
(5)	Capacitance	±5 %		Plating	Sn	100%	(Pb Free)
	tolerance		9	Product	Automotive		
6	Rated Voltage	100 V	100	Grade code	Standard		
7	Thickness	0.8 ± 0.1 mm	11)	Packaging	Cardboard Type, 7" reel(4,000ea)		

B. Reliability Test and Judgement condition

	Performance	Test condition		
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1000hrs@T=150℃		
Exposure	Capacitance Change :	Measurement at 24±2hrs after test conclusion		
	within ±2.5% or ±0.25pF whichever is larger			
	Q: 1000 min			
	IR : More than 10,000 $\mathrm{M}\Omega$ or 500 $\mathrm{M}\Omega imes \mu \mathrm{F}$			
	Whichever is Smaller			
Temperature Cycling	Appearance : No abnormal exterior appearance	1000Cycles		
	Capacitance Change :	Measurement at 24±2hrs after test conclusion		
	within ±2.5% or ±0.25pF whichever is larger	1 cycle condition :		
	Q: 1000 min	-55+0/-3 °C (15±3min) -> Room Temp(1min.)		
	IR : More than 10,000 $\mathrm{M}\Omega$ or 500 $\mathrm{M}\Omega imes \mu \mathrm{F}$	-> 125+3/-0°C(15±3min) -> Room Temp(1min.)		
	Whichever is Smaller			
Destructive Physical	No Defects or abnormalities	Per EIA 469		
Analysis				
Moisture Resistance	Appearance : No abnormal exterior appearance	10Cycles, t=24hrs/cycle		
	Capacitance Change :	Heat (25~65℃) and humidity (80~98%), Unpowered		
	within ±2.5% or ±0.25pF whichever is larger	measurement at 24±2hrs after test conclusion		
	Q: 350 min			
	IR : More than 10,000 $\mathrm{M}\Omega$ or 500 $\mathrm{M}\Omega imes \mu \mathrm{F}$			
	Whichever is Smaller			
Humidity Bias	Appearance : No abnormal exterior appearance	1000hrs 85°C/85%RH, Rated Voltate and 1.3~1.5V,		
	Capacitance Change :	Add 100kohm resistor		
	within ±2.5% or ±0.25pF whichever is larger	Measurement at 24±2hrs after test conclusion		
	Q: 200 min	The charge/discharge current is less than 50mA.		
	IR : More than 500MΩ or 25MΩ×μF			
	Whichever is Smaller			
High Temperature	Appearance : No abnormal exterior appearance	1000hrs @ TA=125℃, 200% Rated Voltage,		
Operating Life	Capacitance Change :	Measurement at 24±2hrs after test conclusion		
	within ±3.0% or ±0.3pF whichever is larger	The charge/discharge current is less than 50mA.		
	Q: 350 min			
	IR : More than 10,000MΩ or 500MΩ×μF			
	Whichever is Smaller			

	Performance	Test condition				
External Visual	No abnormal exterior appearance	Visual inspection				
Physical Dimensions	Within the specified dimensions	Using The calipers				
Mechanical Shock	Appearance: No abnormal exterior appearance Capacitance Change: within ±2.5% or ±0.25pF whichever is larger Q, IR: initial spec.	Three shocks in each direction should be applied along 3 mutually perpendicular axes of the test specimen (18 shocks) Peakvalue Duration Wave Velocity 1,500G 0.5ms Half sine 4.7m/sec.				
Vibration	Appearance: No abnormal exterior appearance Capacitance Change: within ±2.5% or ±0.25pF whichever is larger Q, IR: initial spec.	5g's for 20min., 12cycles each of 3 orientations, Use 8"x5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10~2000Hz.				
Resistance to	Appearance : No abnormal exterior appearance	Solder pot : 260±5℃, 10±1sec.				
Solder Heat	Capacitance Change : within ±2.5% or ±0.25pF whichever is larger Q, IR : initial spec.					
Thermal Shock	Appearance: No abnormal exterior appearance Capacitance Change: within ±2.5% or ±0.25pF whichever is larger Q, IR: initial spec.	-55°C/+125°C. Note: Number of cycles required-300, Maximum transfer time-20 sec, Dwell time-15min. Air-Air				
ESD	Appearance: No abnormal exterior appearance Capacitance Change: within ±2.5% or ±0.25pF whichever is larger Q, IR: initial spec.	AEC-Q200-002				
Solderability	95% of the terminations is to be soldered evenly and continuously	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5°C c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5°C solder: a solution ethanol and rosin				
Electrical	Capacitance : Within specified tolerance	The Capacitance /Q should be measured at 25 °C,				
Characterization	Q: 1000 max. IR(25℃): More than 100,000MΩ or 1,000MΩ×μF IR(125℃): More than10,000MΩ or 100MΩ×μF Whichever is Smaller Dielectric Strength	1 Mb±10%, 0.5~5Vrms I.R. should be measured with a DC voltage not exceeding Rated Voltage @25℃, @125℃ for 60~120 sec. Dielectric Strength: 250% of the rated voltage for 1~5 seconds				
Board Flex	Appearance: No abnormal exterior appearance Capacitance Change: within ±5.0% or ±0.5pF whichever is larger	Bending to the limit (3mm) for 5 seconds				
Terminal	Appearance : No abnormal exterior appearance	10N, for 60±1 sec.				
Strength(SMD)	Capacitance Change : within ±2.5% or ±0.25pF whichever is larger					
Beam Load	Destruction value should not be exceed Chip Length < 2.5mm a) Chip Thickness > 0.5mm : 20N b) Chip Thickness ≤ 0.5mm : 8N	Beam speed 0.5±0.05mm/sec				
Temperature	COG					
Characteristics	(From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃)					

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}\!\!\mathrm{C}$, 10sec. Max)

Meet IPC/JEDEC J-STD-020 D Standard

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.